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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of)	
Bravek, et al.)	Examiner Edmondson
Serial Number: 09/917,483)	Group Art Unit 1725
Filed: 07/27/2001)	AMENDMENT
For: Circuit Board Having)	
Improved Soldering)	
Characteristics)	

Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

This Amendment is in response to the Office action mailed June 05, 2003. Please amend the above referenced patent application as follows.

Charge or credit any large business entity fees to Deposit Account 10-0230.

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